

LM2524D/LM3524D Regulating Pulse Width Modulator

General Description

The LM3524D family is an improved version of the industry standard LM3524. It has improved specifications and additional features yet is pin for pin compatible with existing 3524 families. New features reduce the need for additional external circuitry often required in the original version.

The LM3524D has a $\pm 1\%$ precision 5V reference. The current carrying capability of the output drive transistors has been raised to 200 mA while reducing V_{CEsat} and increasing V_{CE} breakdown to 60V. The common mode voltage range of the error-amp has been raised to 5.5V to eliminate the need for a resistive divider from the 5V reference.

In the LM3524D the circuit bias line has been isolated from the shut-down pin. This prevents the oscillator pulse amplitude and frequency from being disturbed by shut-down. Also at high frequencies (300 kHz) the max. duty cycle per output has been improved to 44% compared to 35% max. duty cycle in other 3524s.

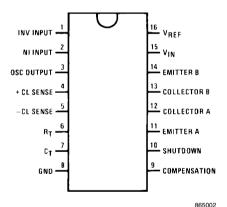
In addition, the LM3524D can now be synchronized externally, through pin 3. Also a latch has been added to insure one

pulse per period even in noisy environments. The LM3524D includes double pulse suppression logic that insures when a shut-down condition is removed the state of the T-flip-flop will change only after the first clock pulse has arrived. This feature prevents the same output from being pulsed twice in a row, thus reducing the possibility of core saturation in push-pull designs.

Features

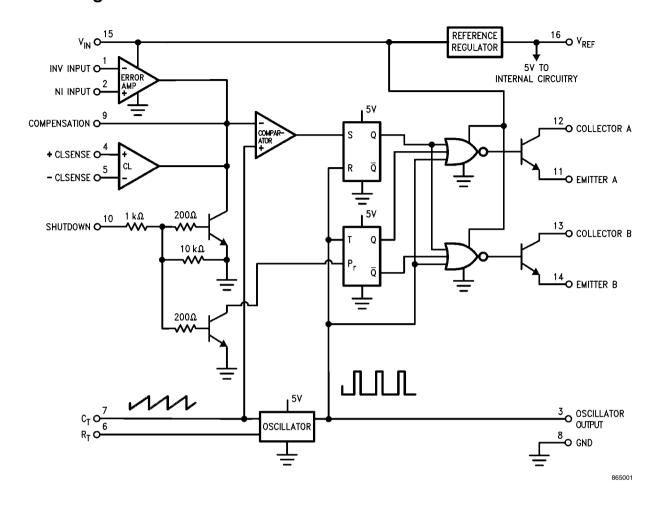
- Fully interchangeable with standard LM3524 family
- ±1% precision 5V reference with thermal shut-down
- Output current to 200 mA DC
- 60V output capability
- Wide common mode input range for error-amp
- One pulse per period (noise suppression)
- Improved max. duty cycle at high frequencies
- Double pulse suppression
- Synchronize through pin 3

Connection Diagram



Top View
Order Number LM2524DN or LM3524DN
See NS Package Number N16E
Order Number LM3524DM
See NS Package Number M16A

Block Diagram



260°C

Absolute Maximum Ratings (Note 5)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage 40V
Collector Supply Voltage
(LM2524D) 55V
(LM3524D) 40V
Output Current DC (each) 200 mA
Oscillator Charging Current (Pin 7) 5 mA

Internal Power Dissipation 1W

Operating Junction Temperature

Range (Note 2)

LM2524D -40°C to +125°C

LM3524D 0°C to +125°C

Maximum Junction Temperature 150°

Storage Temperature Range -65°C to +150°C

Lead Temperature (Soldering 4 sec.)

M, N Pkg.

Electrical Characteristics

(Note 1)

Symbol	Parameter	Conditions	LM2524D			LM3524D			
			Tested		Design		Tested	Design	Units
			Тур	Limit Lir	Limit	Тур	p Limit	Limit	
				(Note 3)	(Note 4)		(Note 3)	(Note 4)	
REFERENC	CE SECTION								
V _{REF}	Output Voltage		5	4.85	4.80	5	4.75		V_{Min}
				5.15	5.20		5.25		V _{Max}
V _{RLine}	Line Regulation	V _{IN} = 8V to 40V	10	15	30	10	25	50	mV _{Max}
V_{RLoad}	Load Regulation	$I_L = 0 \text{ mA to } 20 \text{ mA}$	10	15	25	10	25	50	mV _{Max}
$\frac{\Delta V_{ ext{IN}}}{\Delta V_{ ext{REF}}}$	Ripple Rejection	f = 120 Hz	66			66			dB
I _{os}	Short Circuit	V _{REF} = 0		25			25		mA Min
	Current		50			50			
				180			200		mA Max
N _O	Output Noise	10 Hz ≤ f ≤ 10 kHz	40		100	40		100	μV _{rms Ma}
	Long Term	T _A = 125°C	20			20			mV/kHr
	Stability								
OSCILLATO	OR SECTION								
f _{osc}	Max. Freq.	$R_T = 1k, C_T = 0.001 \mu F$ (Note 7)	550		500	350			kHz _{Min}
f _{osc}	Initial	$R_T = 5.6k, C_T = 0.01 \mu F$		17.5			17.5		kHz _{Min}
	Accuracy	(Note 7)	20			20			
				22.5			22.5		kHz _{Max}
		$R_T = 2.7k, C_T = 0.01 \mu F$		34			30		kHz _{Min}
		(Note 7)	38			38			
				42			46		kHz _{Max}
Δf_{OSC}	Freq. Change with V _{IN}	V _{IN} = 8 to 40V	0.5	1		0.5	1.0		% _{Max}
Δf_{OSC}	Freq. Change	$T_A = -55^{\circ}C \text{ to } +125^{\circ}C$							
	with Temp.	at 20 kHz R _T = 5.6k,	5			5			%
		C _T = 0.01 μF							
V _{OSC}	Output Amplitude	$R_T = 5.6k, C_T = 0.01 \mu F$	3	2.4		3	2.4		V _{Min}
	(Pin 3) (Note 8)	D 50 0 00 =		4 -					
t _{PW}	Output Pulse	$R_T = 5.6k, C_T = 0.01 \mu F$	0.5	1.5		0.5	1.5		μs _{Max}
	Width (Pin 3)								.,
	Sawtooth Peak Voltage	$R_T = 5.6k, C_T = 0.01 \mu F$	3.4	3.6	3.8		3.8		V _{Max}

			LM2524D			LM3524D			
Symbol	Parameter	Conditions		Tested	Design		Tested	Design	Units
•		Containono	Тур	Limit	Limit	Тур	Limit	Limit	
			''	(Note 3)	(Note 4)	**	(Note 3)	(Note 4)	
	Sawtooth Valley	$R_T = 5.6k, C_T = 0.01 \mu F$	1.1	0.8	0.6		0.6	, ,	V _{Min}
	Voltage								IVIIII
FRROR-AM	IP SECTION						<u> </u>		
V _{IO}	Input Offset	V _{CM} = 2.5V	2	8	10	2	10		mV _{Ma}
V IO	Voltage	V _{CM} - 2.3 V	-	0	10	-	10		III V Ma
<u> </u>	Input Bias	V _{CM} = 2.5V	1	8	10	1	10		
I _{IB}	·	V _{CM} - 2.3V	'	0	10	'	10		μA _{Ma}
	Current	V 0.5V	 		_				
I _{IO}	Input Offset Current	V _{CM} = 2.5V	0.5	1.0	1	0.5	1		μA _{Ma}
I _{cosi}	Compensation	$V_{IN(I)} - V_{IN(NI)} = 150 \text{ mV}$		65			65		μA _{Mi}
	Current (Sink)		95			95			- 1011
	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			125			125		μA _{Ma}
I _{coso}	Compensation	$V_{IN(NI)} - V_{IN(I)} = 150 \text{ mV}$	+	-125			-125		μΑ _{Mi}
-0000	Current (Source)	- IN(NI) - IN(I) - 100 IIIV	-95	0		_95	0		⊢ M^Mi
	Current (Source)		-93	-65		-93	_65		
Δ	010					00		00	μA _{Ma}
A _{VOL}	Open Loop Gain	$R_L = \infty$, $V_{CM} = 2.5 \text{ V}$	80	74	60	80	70	60	dB _{Mi}
VCMR	Common Mode			1.5	1.4		1.5		V_{Min}
	Input Voltage			5.5	5.4		5.5		V _{Max}
	Range								
CMRR	Common Mode		90	80		90	80		dB _{Mi}
	Rejection Ratio								
G _{BW}	Unity Gain Bandwidth	$A_{VOL} = 0 \text{ dB}, V_{CM} = 2.5V$	3			2			MHz
V _O	Output Voltage	$R_L = \infty$		0.5			0.5		V _{Min}
	Swing			5.5			5.5		V _{Max}
PSRR	Power Supply	V _{IN} = 8 to 40V	80		70	80	65		db _{Mir}
	Rejection Ratio								IVIII
COMPARA:	TOR SECTION	1					l		
	Minimum Duty	Pin 9 = 0.8V,	0	0	1	0	<u> </u>		0/_
ton.	Cycle		"	U		"	0		% _{Max}
tosc	ļ ·	$[R_T = 5.6k, C_T = 0.01 \mu F]$							
<u>ton</u>	Maximum Duty	Pin 9 = 3.9V,	49	45		49	45		% _{Mir}
tosc	Cycle	$[R_T = 5.6k, C_T = 0.01 \mu F]$							
ton	Maximum Duty	Pin 9 = 3.9V,	44	35		44	35		% _{Mir}
tosc	Cycle	$[R_T = 1k, C_T = 0.001 \mu F]$							
V _{COMPZ}	Input Threshold (Pin 9)	Zero Duty Cycle	1			1			V
V _{COMPM}	Input Threshold	Maximum Duty Cycle	3.5			3.5			V
* COMPM	(Pin 9)	20., 0,00	5.5			5.5			•
I _{IB}	Input Bias		-1			-1			μA
.IR	Current		-'			-'			μΑ
CHDDENT		1			<u> </u>	<u> </u>	l	<u> </u>	<u> </u>
	LIMIT SECTION	l.,		100	1		100		,1/
V_{SEN}	Sense Voltage	$V_{(Pin 2)} - V_{(Pin 1)} \ge$		180			180		mV _M
		150 mV	200			200			
				220			220		mV _{Ma}
TC-V _{sense}	Sense Voltage T.C.		0.2			0.2			mV/°

	Parameter	Conditions		LM2524D			LM3524D		
Symbol				Tested	Design		Tested	Design	Units
			Тур	Limit	Limit	Тур	Limit	Limit	
				(Note 3)	(Note 4)		(Note 3)	(Note 4)	
	Common Mode		-0.7			-0.7			V _{Min}
	Voltage Range	$V_5 - V_4 = 300 \text{ mV}$	1			1			V _{Max}
SHUT DOV	VN SECTION								
V _{SD}	High Input	V _(Pin 2) − V _(Pin 1) ≥	1	0.5		1	0.5		V _{Min}
	Voltage	150 mV		1.5			1.5		V_{Max}
I _{SD}	High Input	I _(pin 10)	1			1			mA
	Current	,							
OUTPUT S	ECTION (EACH OU	TPUT)							
V _{CES}	Collector Emitter	I _C ≤ 100 μA		55			40		V_{Min}
	Voltage Breakdown								
I _{CES}	Collector Leakage	V _{CE} = 60V							
	Current	V _{CE} = 55V	0.1	50					μA_{Ma}
		V _{CE} = 40V				0.1	50		
V _{CESAT}	Saturation	I _E = 20 mA	0.2	0.5		0.2	0.7		V _{Max}
	Voltage	I _E = 200 mA	1.5	2.2		1.5	2.5		
V _{EO}	Emitter Output	I _E = 50 mA	18	17		18	17		V_{Min}
	Voltage								
t _R	Rise Time	$V_{IN} = 20V,$							
		I _E = -250 μA	200			200			ns
		$R_C = 2k$							
t _F	Fall Time	$R_C = 2k$	100			100			ns
SUPPLY C	HARACTERISTICS S	1						,	
V_{IN}	Input Voltage	After Turn-on		8			8		V_{Mir}
	Range			40			40		V _{Max}
Т	Thermal Shutdown	(Note 2)	160			160			°C
	Temp.	101/(11 : 0)					40		
I _{IN}	Stand By Current	V _{IN} = 40V (Note 6)	5	10		5	10		mA

Note 1: Unless otherwise stated, these specifications apply for $T_A = T_J = 25^{\circ}\text{C}$. Boldface numbers apply over the rated temperature range: LM2524D is -40° to 85°C and LM3524D is 0°C to 70°C . $V_{\text{IN}} = 20\text{V}$ and $f_{\text{OSC}} = 20$ kHz.

Note 2: For operation at elevated temperatures, devices in the N package must be derated based on a thermal resistance of 86°C/W, junction to ambient. Devices in the M package must be derated at 125°C/W, junction to ambient.

Note 3: Tested limits are guaranteed and 100% tested in production.

Note 4: Design limits are guaranteed (but not 100% production tested) over the indicated temperature and supply voltage range. These limits are not used to calculate outgoing quality level.

Note 5: Absolute maximum ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

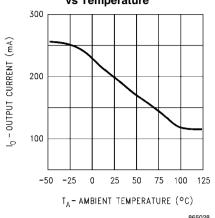
Note 6: Pins 1, 4, 7, 8, 11, and 14 are grounded; Pin 2 = 2V. All other inputs and outputs open.

Note 7: The value of a C_t capacitor can vary with frequency. Careful selection of this capacitor must be made for high frequency operation. Polystyrene was used in this test. NPO ceramic or polypropylene can also be used.

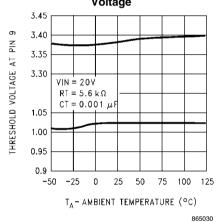
Note 8: OSC amplitude is measured open circuit. Available current is limited to 1 mA so care must be exercised to limit capacitive loading of fast pulses.

Typical Performance Characteristics

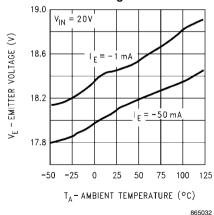




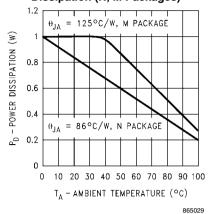
Maximum & Minimum Duty Cycle Threshold Voltage



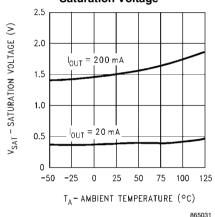
Output Transistor Emitter Voltage



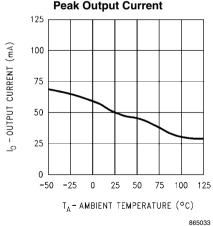
Maximum Average Power Dissipation (N, M Packages)

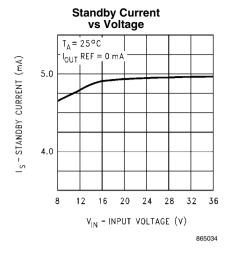


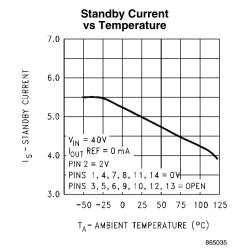
Output Transistor Saturation Voltage

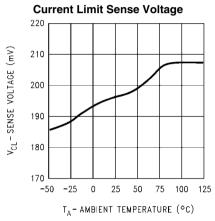


Reference Transistor Peak Output Current

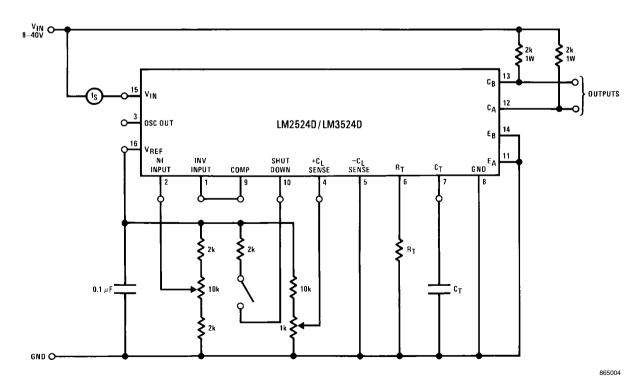








Test Circuit

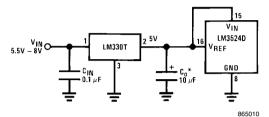


Functional Description

INTERNAL VOLTAGE REGULATOR

The LM3524D has an on-chip 5V. 50 mA, short circuit protected voltage regulator. This voltage regulator provides a supply for all internal circuitry of the device and can be used as an external reference.

For input voltages of less than 8V the 5V output should be shorted to pin $\bar{15}$, V_{IN} , which disables the 5V regulator. With these pins shorted the input voltage must be limited to a maximum of 6V. If input voltages of 6V-8V are to be used, a preregulator, as shown in Figure 1, must be added.



*Minimum C_O of 10 µF required for stability.

FIGURE 1.

OSCILLATOR

The LM3524D provides a stable on-board oscillator. Its frequency is set by an external resistor, R_T and capacitor, C_T. A graph of R_T, C_T vs oscillator frequency is shown is *Figure 2*. The oscillator's output provides the signals for triggering an internal flip-flop, which directs the PWM information to the outputs, and a blanking pulse to turn off both outputs during transitions to ensure that cross conduction does not occur. The width of the blanking pulse, or dead time, is controlled by the value of C_T , as shown in Figure 3. The recommended values of R_T are 1.8 k Ω to 100 k Ω , and for C_T , 0.001 μF to 0.1

If two or more LM3524D's must be synchronized together, the easiest method is to interconnect all pin 3 terminals, tie all pin 7's (together) to a single C_T , and leave all pin 6's open except one which is connected to a single R_T. This method works well unless the LM3524D's are more than 6 apart.

A second synchronization method is appropriate for any circuit layout. One LM3524D, designated as master, must have its $R_{\tau}C_{\tau}$ set for the correct period. The other slave LM3524D (s) should each have an R_TC_T set for a 10% longer period. All pin 3's must then be interconnected to allow the master to properly reset the slave units.

The oscillator may be synchronized to an external clock source by setting the internal free-running oscillator frequency 10% slower than the external clock and driving pin 3 with a pulse train (approx. 3V) from the clock. Pulse width should be greater than 50 ns to insure full synchronization.

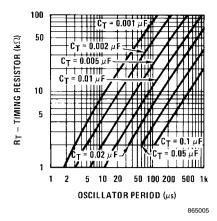


FIGURE 2.

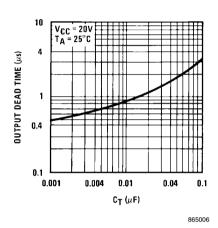


FIGURE 3.

ERROR AMPLIFIER

8

The error amplifier is a differential input, transconductance amplifier. Its gain, nominally 86 dB, is set by either feedback or output loading. This output loading can be done with either purely resistive or a combination of resistive and reactive components. A graph of the amplifier's gain vs output load resistance is shown in Figure 4.

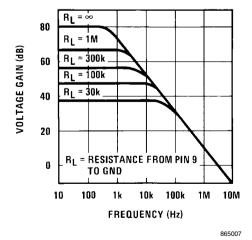


FIGURE 4.

The output of the amplifier, or input to the pulse width modulator, can be overridden easily as its output impedance is very high ($Z_{\rm O}$ 5 M Ω). For this reason a DC voltage can be applied to pin 9 which will override the error amplifier and force a particular duty cycle to the outputs. An example of this could be a non-regulating motor speed control where a variable voltage was applied to pin 9 to control motor speed. A graph of the output duty cycle vs the voltage on pin 9 is shown in *Figure 5*.

The duty cycle is calculated as the percentage ratio of each output's ON-time to the oscillator period. Paralleling the outputs doubles the observed duty cycle.

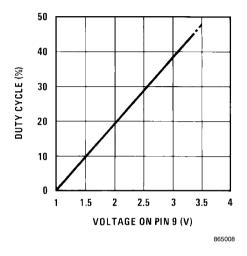


FIGURE 5.

The amplifier's inputs have a common-mode input range of 1.5V–5.5V. The on board regulator is useful for biasing the inputs to within this range.

CURRENT LIMITING

The function of the current limit amplifier is to override the error amplifier's output and take control of the pulse width. The output duty cycle drops to about 25% when a current limit sense voltage of 200 mV is applied between the $+C_L$ and $-C_L$ sense terminals. Increasing the sense voltage approximately 5% results in a 0% output duty cycle. Care should be taken to ensure the -0.7V to +1.0V input common-mode range is not exceeded.

In most applications, the current limit sense voltage is produced by a current through a sense resistor. The accuracy of this measurement is limited by the accuracy of the sense resistor, and by a small offset current, typically 100 μA , flowing from +CL to –CL.

OUTPUT STAGES

The outputs of the LM3524D are NPN transistors, capable of a maximum current of 200 mA. These transistors are driven 180° out of phase and have non-committed open collectors and emitters as shown in *Figure 6*.

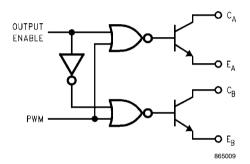
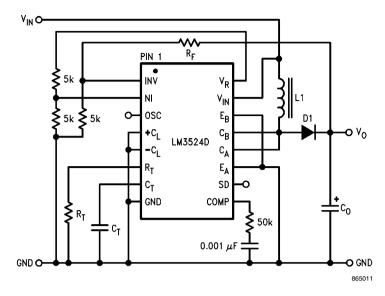


FIGURE 6.

Typical Applications



Design Equations

$$R_F=5k\left(\frac{V_0}{2.5}-1\right)$$

$$\begin{split} f_{OSC} &\simeq \frac{1}{R_T C_T} \\ L1 &= \frac{2.5 V_{IN}^2 \left(V_o - V_{IN}\right)}{f_{OSC} I_o V_o^2} \\ C_o &= \frac{I_o \left(V_o - V_{IN}\right)}{f_{OSC} \Delta V_o V_o} \\ I_{o(MAX)} &= I_{IN} \frac{V_{IN}}{V_o} \end{split}$$

FIGURE 7. Positive Regulator, Step-Up Basic Configuration ($I_{IN(MAX)} = 80 \text{ mA}$)

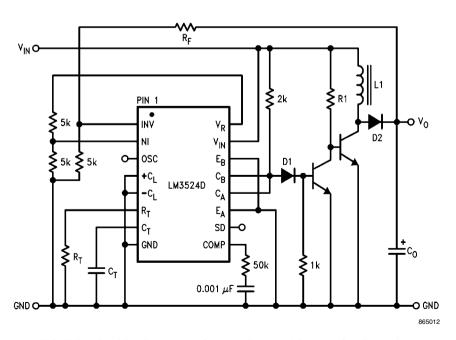
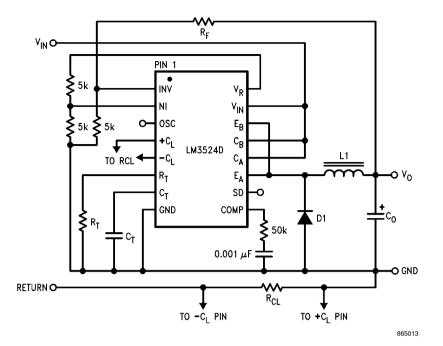


FIGURE 8. Positive Regulator, Step-Up Boosted Current Configuration



Design Equations

$$\begin{split} R_F &= 5 \text{ k}\Omega \left(\frac{V_o}{2.5} - 1\right) \\ R_{CL} &= \frac{\text{Current Limit}}{I_{o(\text{MAX})}} \\ f_{OSC} &\cong \frac{1}{R_T C_T} \\ L1 &= \frac{2.5 V_o \left(V_{IN} - V_o\right)}{I_o \left(V_{IN} f_{OSC}\right)} \\ C_o &= \frac{\left(V_{IN} - V_o\right) V_o T^2}{8 \left.\Delta V_o \left(V_{IN} L\right)} \\ I_{o(\text{MAX})} &= I_{IN} \frac{V_{IN}}{V_o} \end{split}$$

FIGURE 9. Positive Regulator, Step-Down Basic Configuration ($I_{IN(MAX)} = 80 \text{ mA}$)

11

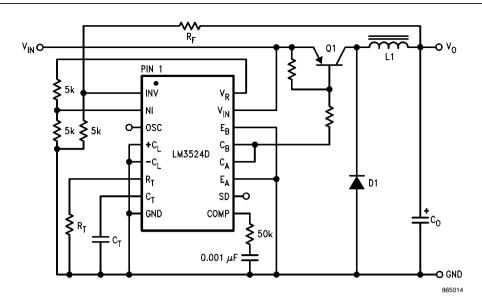
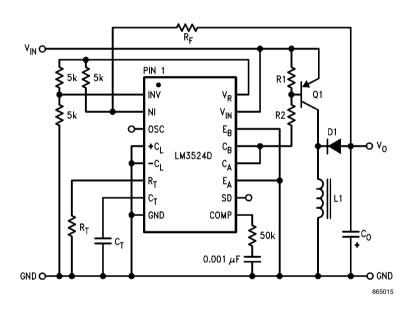


FIGURE 10. Positive Regulator, Step-Down Boosted Current Configuration



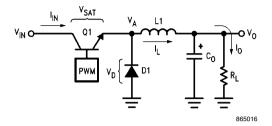
Design Equations

$$\begin{split} R_F &= 5 \text{k} \left(1 - \frac{V_o}{2.5}\right) \\ f_{OSC} &\cong \frac{1}{R_T C_T} \\ L1 &= \frac{2.5 V_{|N|} V_o}{f_{OSC} \left(V_o + V_{|N|}\right) I_o} \\ C_o &= \frac{I_o V_o}{\Delta V_o f_{OSC} \left(V_o + V_{|N|}\right)} \end{split}$$

FIGURE 11. Boosted Current Polarity Inverter

BASIC SWITCHING REGULATOR THEORY AND APPLICATIONS

The basic circuit of a step-down switching regulator circuit is shown in *Figure 12*, along with a practical circuit design using the LM3524D in *Figure 15*.



The circuit works as follows: Q1 is used as a switch, which has ON and OFF times controlled by the pulse width modulator. When Q1 is ON, power is drawn from $V_{\rm IN}$ and supplied to the load through L1; $V_{\rm A}$ is at approximately $V_{\rm IN}$, D1 is reverse biased, and $C_{\rm o}$ is charging. When Q1 turns OFF the inductor L1 will force $V_{\rm A}$ negative to keep the current flowing in it, D1 will start conducting and the load current will flow through D1 and L1. The voltage at $V_{\rm A}$ is smoothed by the L1, $C_{\rm o}$ filter giving a clean DC output. The current flowing through L1 is equal to the nominal DC load current plus some $\Delta I_{\rm L}$ which is due to the changing voltage across it. A good rule of thumb is to set $\Delta I_{\rm LP,P}$ 40% × $I_{\rm O}$.

FIGURE 12. Basic Step-Down Switching Regulator

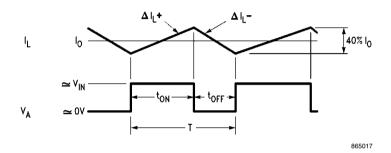


FIGURE 13. Relation of Switch Timing to Inductor Current in Step-Down Regulator

From the relation
$$V_L = L \frac{d_i}{d_t}$$
, $\Delta I_L \cong \frac{V_L T}{L1}$

$$\Delta I_L^+ = \frac{(V_{IN} - V_o) t_{ON}}{I \cdot 1}; \Delta I_L^- = \frac{V_o t_{OFF}}{I \cdot 1}$$

Neglecting V_{SAT} , V_{D} , and settling $\Delta I_{L}^{+} = \Delta I_{L}^{-}$;

$$\boxed{ V_{\text{O}} \cong V_{\text{IN}} \left(\frac{t_{\text{ON}}}{t_{\text{OFF}} + t_{\text{ON}}} \right) } = V_{\text{IN}} \left(\frac{t_{\text{ON}}}{T} \right); }$$

where T = Total Period

The above shows the relation between V_{IN} , V_{o} and duty cycle.

$$I_{\text{IN(DC)}} = I_{\text{OUT(DC)}} \left(\frac{t_{\text{ON}}}{t_{\text{ON}} + t_{\text{OFF}}} \right),$$

as Q1 only conducts during ton.

$$\begin{aligned} P_{IN} &= I_{IN(DC)} \, V_{IN} = (I_{o(DC)}) \left(\frac{t_{ON}}{t_{ON} + t_{OFF}} \right) V_{IN} \\ P_o &= I_o V_o \end{aligned}$$

The efficiency, η , of the circuit is:

$$\begin{split} \eta \text{MAX} &= \frac{P_{\text{O}}}{P_{\text{IN}}} = \frac{I_{\text{O}}V_{\text{O}}}{I_{\text{O}}\frac{(t_{\text{ON}})}{T}V_{\text{IN}} + \frac{(V_{\text{SAT}}\,t_{\text{ON}} + V_{\text{D1}}t_{\text{OFF}})}{T}I_{\text{O}}}{I_{\text{O}}} \\ &= \boxed{\frac{V_{\text{O}}}{V_{\text{O}} + 1}} \text{for } V_{\text{SAT}} = V_{\text{D1}} = 1V. \end{split}$$

 η MAX will be further decreased due to switching losses in Q1. For this reason Q1 should be selected to have the maximum possible f_T , which implies very fast rise and fall times.

CALCULATING INDUCTOR L1

$$\begin{split} t_{ON} &\cong \frac{(\Delta I_L^+) \times L1}{(V_{IN} - V_o)}, t_{OFF} = \frac{(\Delta I_L^-) \times L1}{V_o} \\ t_{ON} + t_{OFF} &= T = \frac{(\Delta I_L^+) \times L1}{(V_{IN} - V_O)} + \frac{(\Delta I_L^-) \times L1}{V_o} \\ &= \frac{0.4 I_o L1}{(V_{IN} - V_o)} + \frac{0.4 I_o L1}{V_o} \end{split}$$

Since $\Delta I_L + = \Delta I_L^- = 0.4 I_o$ Solving the above for L1

$$L1 = \frac{2.5 \, V_o \, (V_{IN} - V_o)}{I_o \, V_{IN} \, f}$$

where: L1 is in Henrys f is switching frequency in Hz

Also, see LM1578 data sheet for graphical methods of inductor selection.

CALCULATING OUTPUT FILTER CAPACITOR Co:

Figure 13 shows L1's current with respect to Q1's t_{ON} and t_{OFF} times (V_A is at the collector of Q1). This curent must flow to the load and C_o . C_o 's current will then be the difference between I_I , and I_o .

$$Ic_o = I_L - I_o$$

From Figure 13 it can be seen that current will be flowing into C_o for the second half of t_{ON} through the first half of t_{OFF} , or a time, $t_{ON}/2 + t_{OFF}/2$. The current flowing for this time is $\Delta I_L/4$. The resulting ΔV_c or ΔV_o is described by:

$$\begin{split} \Delta V_{\text{op-p}} &= \frac{1}{C} \times \frac{\Delta I_L}{4} \times \left(\frac{t_{ON}}{2} + \frac{t_{OFF}}{2}\right) \\ &= \frac{\Delta I_L}{4C} \left(\frac{t_{ON} + t_{OFF}}{2}\right) \\ \text{Since } \Delta I_L &= \frac{V_o(T - t_{ON})}{L1} \text{ and } t_{ON} = \frac{V_oT}{V_{IN}} \\ \Delta V_{\text{op-p}} &= \frac{V_o \left(T - \frac{V_oT}{V_{IN}}\right)}{4C \; L1} \left(\frac{T}{2}\right) = \frac{(V_{IN} - V_o) \; V_oT^2}{8V_{IN}C_oL1} \text{ or } \\ C_o &= \frac{(V_{IN} - V_o) \; V_o \; T^2}{8\Delta V_oV_{IN}L1} \end{split}$$

where: C is in farads, T is $\frac{1}{\text{switching frequency}}$

ΔVo is p-p output ripple

For best regulation, the inductor's current cannot be allowed to fall to zero. Some minimum load current I_o , and thus inductor current, is required as shown below:

$$I_{O(MIN)} = \frac{(V_{IN} - V_o) t_{ON}}{2L1} = \boxed{\frac{(V_{IN} - V_o) V_o}{2fV_{IN}L1}}$$

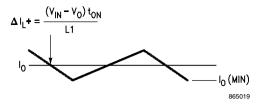


FIGURE 14. Inductor Current Slope in Step-Down Regulator

A complete step-down switching regulator schematic, using the LM3524D, is illustrated in *Figure 15*. Transistors Q1 and Q2 have been added to boost the output to 1A. The 5V regulator of the LM3524D has been divided in half to bias the error amplifier's non-inverting input to within its common-mode range. Since each output transistor is on for half the period, actually 45%, they have been paralleled to allow longer possible duty cycle, up to 90%. This makes a lower possible input voltage. The output voltage is set by:

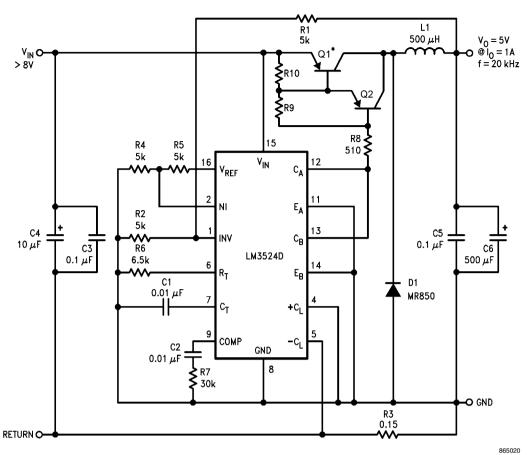
$$V_{o} = V_{NI} \left(1 + \frac{R1}{R2} \right),$$

where $\boldsymbol{V}_{\text{NI}}$ is the voltage at the error amplifier's non-inverting input.

Resistor R3 sets the current limit to:

$$\frac{200 \text{ mV}}{\text{R3}} = \frac{200 \text{ mV}}{0.15} = 1.3 \text{A}.$$

Figures 16, 17 and show a PC board layout and stuffing diagram for the 5V, 1A regulator of Figure 15. The regulator's performance is listed in Table 1.



*Mounted to Staver Heatsink No. V5-1.

Q1 = BD344

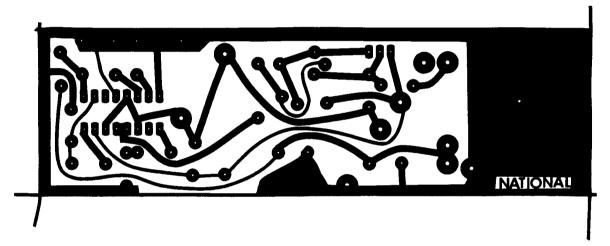
Q2 = 2N5023

L1 = >40 turns No. 22 wire on Ferroxcube No. K300502 Torroid core.

FIGURE 15. 5V, 1 Amp Step-Down Switching Regulator

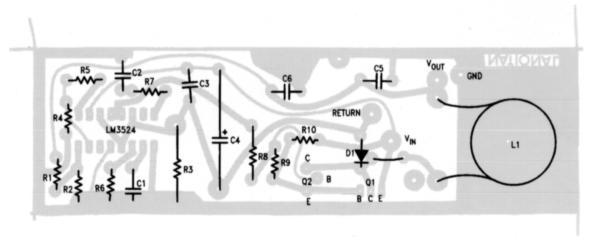
TABLE 1.

Parameter	Conditions	Typical		
		Characteristics		
Output Voltage	$V_{IN} = 10V, I_{o} = 1A$	5V		
Switching Frequency	$V_{IN} = 10V, I_{o} = 1A$ $V_{IN} = 10V, I_{o} = 1A$	20 kHz		
Short Circuit	V _{IN} = 10V	1.3A		
Current Limit				
Load Regulation	V _{IN} = 10V	3 mV		
	$I_0 = 0.2 - 1A$			
Line Regulation	$V_{IN} = 10V$ $I_{o} = 0.2 - 1A$ $\Delta V_{IN} = 10 - 20V$,	6 mV		
	I _o = 1A			
Efficiency	$V_{IN} = 10V, I_{o} = 1A$ $V_{IN} = 10V, I_{o} = 1A$	80%		
Output Ripple	$V_{IN} = 10V, I_{o} = 1A$	10 mVp-p		



865021

FIGURE 16. 5V, 1 Amp Switching Regulator, Foil Side



865022

FIGURE 17. Stuffing Diagram, Component Side

THE STEP-UP SWITCHING REGULATOR

Figure 18 shows the basic circuit for a step-up switching regulator. In this circuit Q1 is used as a switch to alternately apply V_{IN} across inductor L1. During the time, t_{ON} , Q1 is ON and energy is drawn from V_{IN} and stored in L1; D1 is reverse biased and I_o is supplied from the charge stored in C_o . When Q1 opens, t_{OFF} , voltage V1 will rise positively to the point where D1 turns ON. The output current is now supplied through L1, D1 to the load and any charge lost from C_o during t_{ON} is replenished. Here also, as in the step-down regulator, the current through L1 has a DC component plus some ΔI_L . ΔI_L is again selected to be approximately 40% of I_L . Figure 19 shows the inductor's current in relation to Q1's ON and OFF times.

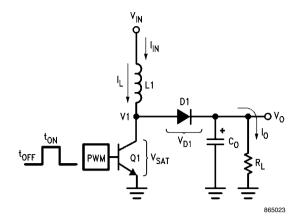


FIGURE 18. Basic Step-Up Switching Regulator

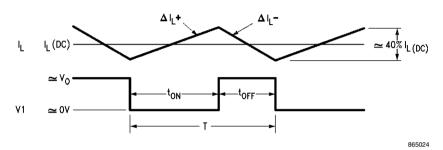


FIGURE 19. Relation of Switch Timing to Inductor Current in Step-Up Regulator

From
$$\Delta I_L = \frac{V_L T}{L}$$
, $\Delta I_L^+ \approx \frac{V_{IN} t_{ON}}{L1}$
and $\Delta I_L^- \approx \frac{(V_O - V_{IN}) t_{OFF}}{L1}$

Since $\Delta I_L + = \Delta I_L -$, $V_{IN}t_{ON} = V_o t_{OFF} - V_{IN}t_{OFF}$, and neglecting V_{SAT} and V_{D1}

$$V_0 \cong V_{IN} \left(1 + \frac{t_{ON}}{t_{OFF}} \right)$$

The above equation shows the relationship between $\rm V_{IN},\,V_{o}$ and duty cycle.

In calculating input current $I_{\text{IN(DC)}}$, which equals the inductor's DC current, assume first 100% efficiency:

$$\begin{split} P_{IN} &= I_{IN(DC)} \, V_{IN} \\ P_{OUT} &= I_o V_o = I_o \, V_{IN} \left(1 \, + \, \frac{t_{ON}}{t_{OFF}} \right) \end{split}$$

for η = 100%, P_{OUT} = P_{IN}

$$I_{O} V_{IN} \left(1 + \frac{t_{ON}}{t_{OFF}} \right) = I_{IN(DC)} V_{IN}$$
$$I_{IN(DC)} = I_{O} \left(1 + \frac{t_{ON}}{t_{OFF}} \right)$$

This equation shows that the input, or inductor, current is larger than the output current by the factor (1 + t_{ON}/t_{OFF}). Since this factor is the same as the relation between V_o and V_{IN} , I_{IN} (DC) can also be expressed as:

$$I_{\text{IN(DC)}} = I_{\text{o}} \left(\frac{V_{\text{o}}}{V_{\text{IN}}} \right)$$

So far it is assumed $\eta=100\%,$ where the actual efficiency or η_{MAX} will be somewhat less due to the saturation voltage of Q1 and forward on voltage of D1. The internal power loss due to these voltages is the average I_L current flowing, or $I_{IN},$ through either V_{SAT} or $V_{D1}.$ For $V_{SAT}=V_{D1}=1V$ this power loss becomes $I_{IN(DC)}$ (1V). η_{MAX} is then:

$$\eta_{\text{MAX}} = \frac{P_{\text{O}}}{P_{\text{IN}}} = \frac{V_{\text{O}}I_{\text{O}}}{V_{\text{O}}I_{\text{O}} + I_{\text{IN}} (1V)} = \frac{V_{\text{O}}I_{\text{O}}}{V_{\text{O}}I_{\text{O}} + I_{\text{O}} \left(1 + \frac{t_{\text{ON}}}{t_{\text{OFF}}}\right)}$$

From V_0 = V_{IN}
$$\left(1 + \frac{t_{ON}}{t_{OFF}}\right)$$

$$\boxed{ \eta_{max} = \frac{V_{IN}}{V_{IN} + 1} }$$

This equation assumes only DC losses, however η_{MAX} is further decreased because of the switching time of Q1 and D1.

In calculating the output capacitor C_o it can be seen that C_o supplies I_o during t_{ON} . The voltage change on C_o during this time will be some $\Delta V_c = \Delta V_o$ or the output ripple of the regulator. Calculation of C_o is:

$$\begin{split} \Delta V_O &= \frac{l_O t_{ON}}{C_O} \text{ or } C_O = \frac{l_O t_{ON}}{\Delta V_O} \\ \text{From } V_O &= V_{IN} \left(\frac{T}{t_{OFF}} \right); t_{OFF} = \frac{V_{IN}}{V_O} T \\ \text{where } T &= t_{ON} + t_{OFF} = \frac{1}{f} \\ t_{ON} &= T - \frac{V_{IN}}{V_O} T = T \left(\frac{V_O - V_{IN}}{V_O} \right) \text{ therefore:} \\ C_O &= \frac{l_O T \left(\frac{V_O - V_{IN}}{V_O} \right)}{\Delta V_O} = \boxed{\frac{l_O \left(V_O - V_{IN} \right)}{f \Delta V_O V_O}} \end{split}$$

where: C_o is in farads, f is the switching frequency, ΔV_o is the p-p output ripple

Calculation of inductor L1 is as follows:

$$L1 = \frac{V_{IN}t_{ON}}{\Delta I_{I}}, \text{ since during } t_{ON},$$

V_{IN} is applied across L1

$$\begin{split} \Delta I_{Lp\text{-}p} &= 0.4 \ I_L = 0.41 \ I_{IN} = 0.4 \ I_o \left(\frac{V_o}{V_{IN}}\right) \text{, therefore:} \\ L1 &= \frac{V_{IN}t_{ON}}{0.4 \ I_o \left(\frac{V_o}{V_{IN}}\right)} \text{ and since } t_{ON} = \frac{T \ (V_o - V_{IN})}{V_o} \\ \hline \left[L1 &= \frac{2.5 \ V_{IN}^2 \ (V_o - V_{IN})}{f \ I_o V_o^2}\right] \end{split}$$

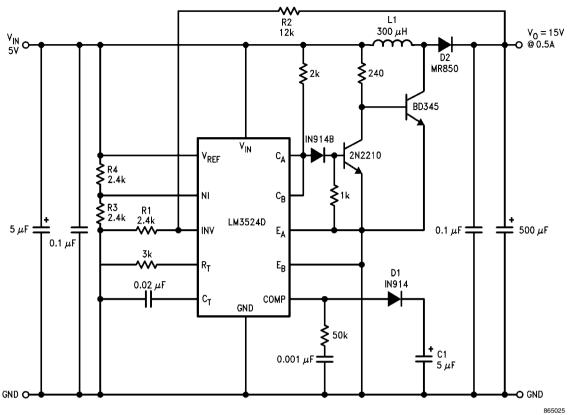
where: L1 is in henrys, f is the switching frequency in Hz To apply the above theory, a complete step-up switching regulator is shown in *Figure 20*. Since V_{IN} is 5V, V_{REF} is tied to V_{IN} . The input voltage is divided by 2 to bias the error amplifier's inverting input. The output voltage is:

$$V_{OUT} = \left(1 + \frac{R2}{R1}\right) \times V_{INV} = 2.5 \times \left(1 + \frac{R2}{R1}\right)$$

The network D1, C1 forms a slow start circuit.

This holds the output of the error amplifier initially low thus reducing the duty-cycle to a minimum. Without the slow start circuit the inductor may saturate at turn-on because it has to supply high peak currents to charge the output capacitor from OV. It should also be noted that this circuit has no supply rejection. By adding a reference voltage at the non-inverting input to the error amplifier, see *Figure 21*, the input voltage variations are rejected.

The LM3524D can also be used in inductorless switching regulators. *Figure 22* shows a polarity inverter which if connected to *Figure 20* provides a –15V unregulated output.



L1 = > 25 turns No. 24 wire on Ferroxcube No. K300502 Toroid core.

FIGURE 20. 15V, 0.5A Step-Up Switching Regulator

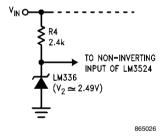


FIGURE 21. Replacing R3/R4 Divider in Figure 20 with Reference Circuit Improves Line Regulation

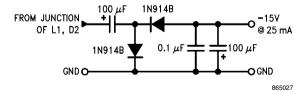
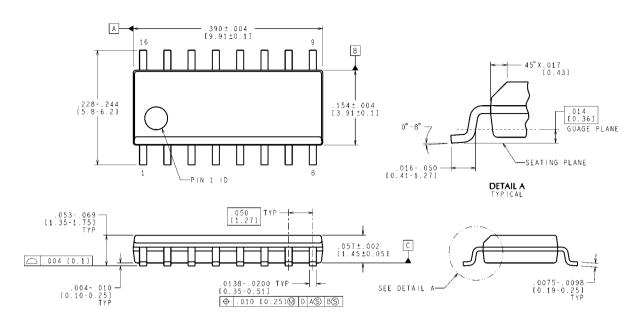


FIGURE 22. Polarity Inverter Provides Auxiliary –15V Unregulated Output from Circuit of Figure 20

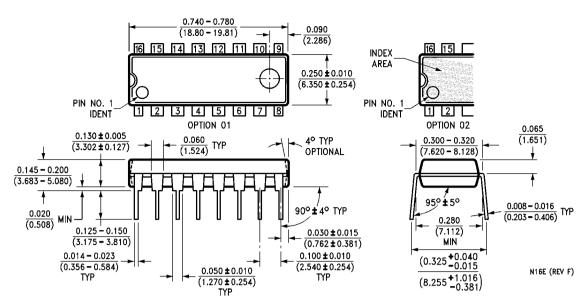
Physical Dimensions inches (millimeters) unless otherwise noted



CONTROLLING DIMENSION IS INCH

M16A (Rev J)

Molded Surface-Mount Package (M) Order Number LM3524DM NS Package Number M16A



Molded Dual-In-Line Package (N)
Order Number LM2524DN or LM3524DN
NS Package Number N16E

Notes

For more National Semiconductor product information and proven design tools, visit the following Web sites at:

Pr	oducts	Design Support			
Amplifiers	www.national.com/amplifiers	WEBENCH	www.national.com/webench		
Audio	www.national.com/audio	Analog University	www.national.com/AU		
Clock Conditioners	www.national.com/timing	App Notes	www.national.com/appnotes		
Data Converters	www.national.com/adc	Distributors	www.national.com/contacts		
Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green		
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging		
Interface	www.national.com/interface	Quality and Reliability	www.national.com/quality		
LVDS	www.national.com/lvds	Reference Designs	www.national.com/refdesigns		
Power Management	www.national.com/power	Feedback	www.national.com/feedback		
Switching Regulators	www.national.com/switchers				
LDOs	www.national.com/ldo				
LED Lighting	www.national.com/led				
PowerWise	www.national.com/powerwise				
Serial Digital Interface (SDI)	www.national.com/sdi				
Temperature Sensors	www.national.com/tempsensors				
Wireless (PLL/VCO)	www.national.com/wireless				

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS. PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2008 National Semiconductor Corporation

For the most current product information visit us at www.national.com



National Semiconductor Americas Technical Support Center Email: support@nsc.com Tel: 1-800-272-9959 National Semiconductor Europe Technical Support Center Email: europe.support@nsc.com German Tel: +49 (0) 180 5010 771 English Tel: +44 (0) 870 850 4288 National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com National Semiconductor Japan Technical Support Center Email: ion.feedback@nsc.com